

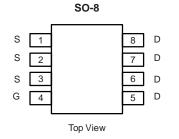
# P-Channel 30-V (D-S) MOSFET

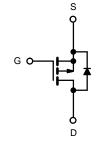
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A)			
	0.033 at V <sub>GS</sub> = - 10 V	- 5.8			
- 30	0.043 at V <sub>GS</sub> = - 6 V	- 5.0			
	0.056 at V <sub>GS</sub> = - 4.5 V	- 4.4			

#### **FEATURES**

- Halogen-free According to IEC 61249-2-21
  Definition
- TrenchFET<sup>®</sup> Power MOSFET
- Compliant to RoHS Directive 2002/95/EC







P-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> $T_A = 25 \text{ °C}$ , unless otherwise noted						
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V <sub>DS</sub>	- 30		V	
Gate-Source Voltage		V <sub>GS</sub>	± 20			
	T <sub>A</sub> = 25 °C	– I <sub>D</sub>	- 5.8	- 4.1		
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 70 °C		- 4.6	- 3.2		
Pulsed Drain Current		I <sub>DM</sub>	- 30		A	
Continuous Source Current (Diode Conduction) <sup>a</sup>		I <sub>S</sub>	- 2.3	- 1.1		
	T <sub>A</sub> = 25 °C	PD	2.5	2.5 1.3	W	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 70 °C	٢D	1.6	0.8	vv	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55	to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
	t ≤ 10 s	- R <sub>thJA</sub>	40	50	
Maximum Junction-to-Ambient <sup>a</sup>	Steady State		70	95	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	24	30	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

Parameter	Symbol	Test Conditions	Min.	Typ. <sup>a</sup>	Max.	Unit
Static				÷		
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$			- 2.0	V
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zana Osta Mallana Dusia Osumat	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	
Zero Gate Voltage Drain Current		$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 \text{ °C}$			- 5	μA
		$V_{DS} \le$ - 10 V, $V_{GS}$ = - 10 V - 2				•
On-State Drain Current <sup>b</sup>	I <sub>D(on)</sub>	$V_{DS}$ $\leq$ - 5 V, $V_{GS}$ = - 4.5 V	- 5			A
		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 5.8 A	0.033			
Drain-Source On-State Resistance <sup>b</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 6 V, I <sub>D</sub> = - 5 A		0.043		Ω
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 4.4 A		0.056		
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 5.8 A		13		S
Diode Forward Voltage <sup>b</sup>	$V_{SD}$	I <sub>S</sub> = - 2.3 A, V <sub>GS</sub> = 0 V		- 0.8	- 1.1	V
Dynamic <sup>a</sup>						
Total Gate Charge	Qg			16	24	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ = - 15 V, $V_{GS}$ = - 10 V, $I_{D}$ = - 3.5 A		2.3		nC
Gate-Drain Charge	Q <sub>gd</sub>			4.5		
Gate Resistance	Rg			8.8		Ω
Turn-On Delay Time	t <sub>d(on)</sub>			14	25	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 15 $\Omega$		14	25	
Turn-Off Delay Time	t <sub>d(off)</sub>	${\rm I}_{\rm D}\cong$ - 1 A, ${\rm V}_{\rm GEN}$ = - 10 V, ${\rm R}_{\rm g}$ = 6 $\Omega$		42	70	ns
Fall Time	t <sub>f</sub>			30	50	
Source-Drain Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = - 1.2 A, dl/dt = 100 A/μs		30	60	

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

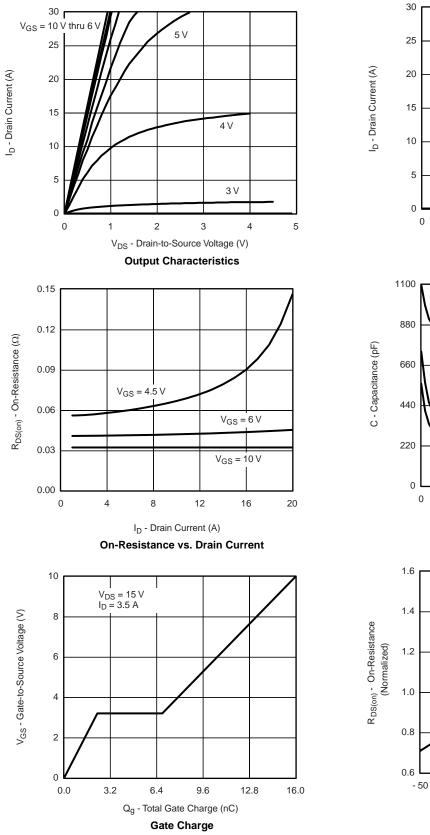
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

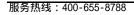
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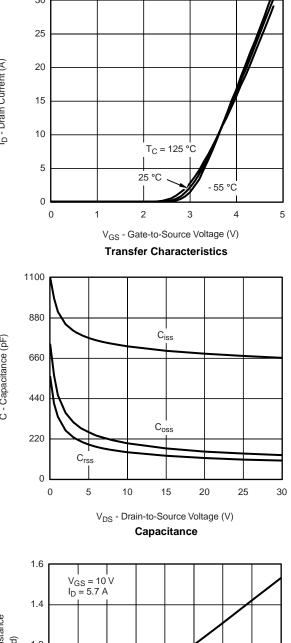
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### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







- 25

T<sub>J</sub> - Junction Temperature (°C)

**On-Resistance vs. Junction Temperature** 



 $I_{D} = 5.8 \text{ A}$ 

2

10-2

100

4

6

V<sub>GS</sub> - Gate-to-Source Voltage (V)

10-1

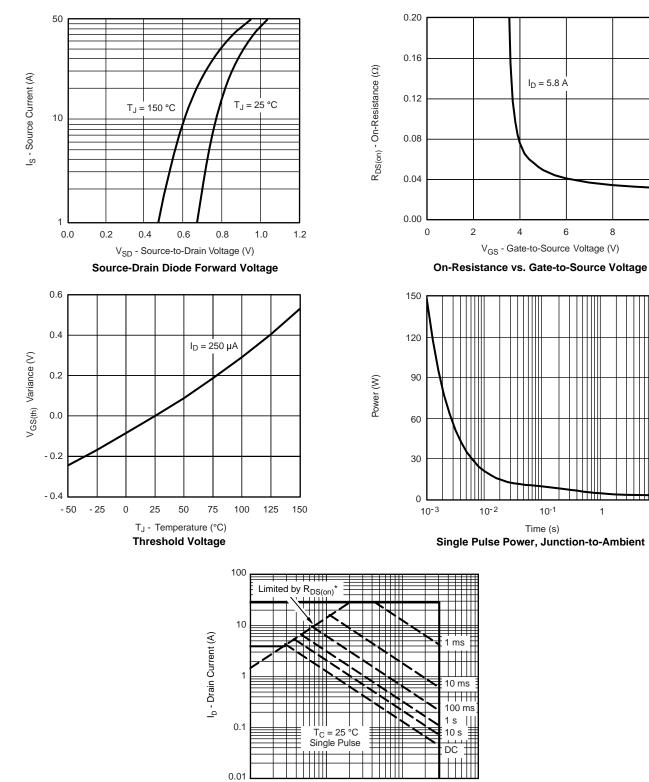
Time (s)

1

8

10

10



0.1

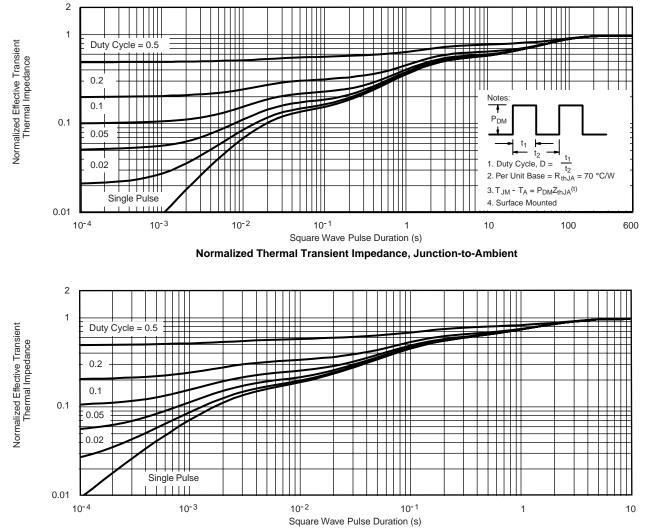
1

 $V_{DS}$  - Drain-to-Source Voltage (V) \*  $V_{DS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified Safe Operating Area, Junction-to-Foot

10

#### TYPICAL CHARACTERISTICS 25 C, unless otherwise noted





#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Normalized Thermal Transient Impedance, Junction-to-Foot



### SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012

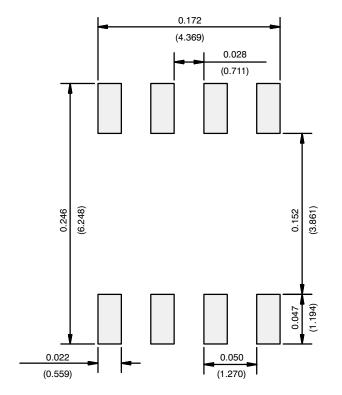




	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
A	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050	50 BSC		
н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498						



### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)



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